

Welcome to E-XFL.COM

#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

| Details                        |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 1452  |
| Number of Logic Elements/Cells | -   |
| Total RAM Bits                 | -   |
| Number of I/O                  | 81  |
| Number of Gates                | 24000   |
| Voltage - Supply               | 3V ~ 3.6V, 4.75V ~ 5.25V                                      |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 70°C (TA)   |
| Package / Case                 | 100-TQFP  |
| Supplier Device Package        | 100-VQFP (14x14)  |
| Purchase URL                   | https://www.e-xfl.com/product-detail/microsemi/a54sx16-2vq100 |
|                                |   |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and clock enable (using the S0 and S1 lines) control signals (Figure 1-2). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional

flexibility while allowing mapping of synthesized functions into the SX FPGA. The clock source for the R-cell can be chosen from either the hardwired clock or the routed clock.



Figure 1-1 • SX Family Interconnect Elements



Figure 1-2 • R-Cell

The C-cell implements a range of combinatorial functions up to 5-inputs (Figure 1-3 on page 1-3). Inclusion of the DB input and its associated inverter function dramatically increases the number of combinatorial functions that can be implemented in a single module from 800 options in previous architectures to more than 4,000 in the SX architecture. An example of the improved flexibility enabled by the inversion capability is the ability to integrate a 3-input exclusive-OR function into a single C-cell. This facilitates construction of 9-bit parity-tree functions with 2 ns propagation delays. At the same time, the C-cell structure is extremely synthesis friendly, simplifying the overall design and reducing synthesis time.



## Chip Architecture

The SX family chip architecture provides a unique approach to module organization and chip routing that delivers the best register/logic mix for a wide variety of new and emerging applications.

## **Module Organization**

Actel has arranged all C-cell and R-cell logic modules into horizontal banks called *clusters*. There are two types of *clusters*: Type 1 contains two C-cells and one R-cell, while Type 2 contains one C-cell and two R-cells. To increase design efficiency and device performance, Actel has further organized these modules into *SuperClusters* (Figure 1-4). SuperCluster 1 is a two-wide grouping of Type 1 clusters. SuperCluster 2 is a two-wide group containing one Type 1 cluster and one Type 2 cluster. SX devices feature more SuperCluster 1 modules than SuperCluster 2 modules because designers typically require significantly more combinatorial logic than flipflops.



Figure 1-3 • C-Cell



*Figure 1-4* • Cluster Organization



DirectConnect is a horizontal routing resource that provides connections from a C-cell to its neighboring Rcell in a given SuperCluster. DirectConnect uses a hardwired signal path requiring no programmable interconnection to achieve its fast signal propagation time of less than 0.1 ns.

FastConnect enables horizontal routing between any two logic modules within a given SuperCluster and vertical routing with the SuperCluster immediately below it. Only one programmable connection is used in a FastConnect path, delivering maximum pin-to-pin propagation of 0.4 ns.

In addition to DirectConnect and FastConnect, the architecture makes use of two globally oriented routing resources known as segmented routing and high-drive routing. The Actel segmented routing structure provides a variety of track lengths for extremely fast routing between SuperClusters. The exact combination of track lengths and antifuses within each path is chosen by the 100 percent automatic place-and-route software to minimize signal propagation delays.

The Actel high-drive routing structure provides three clock networks. The first clock, called HCLK, is hardwired from the HCLK buffer to the clock select multiplexer (MUX) in each R-cell. This provides a fast propagation path for the clock signal, enabling the 3.7 ns clock-to-out (pin-to-pin) performance of the SX devices. The hardwired clock is tuned to provide clock skew as low as 0.25 ns. The remaining two clocks (CLKA, CLKB) are global clocks that can be sourced from external pins or from internal logic signals within the SX device.

## **Other Architectural Features**

## Technology

The Actel SX family is implemented on a high-voltage twin-well CMOS process using 0.35  $\mu$  design rules. The metal-to-metal antifuse is made up of a combination of amorphous silicon and dielectric material with barrier metals and has a programmed ("on" state) resistance of 25  $\Omega$  with a capacitance of 1.0 fF for low signal impedance.

#### Performance

The combination of architectural features described above enables SX devices to operate with internal clock frequencies exceeding 300 MHz, enabling very fast execution of even complex logic functions. Thus, the SX family is an optimal platform upon which to integrate the functionality previously contained in multiple CPLDs. In addition, designs that previously would have required a gate array to meet performance goals can now be integrated into an SX device with dramatic improvements in cost and time to market. Using timingdriven place-and-route tools, designers can achieve highly deterministic device performance. With SX devices, designers do not need to use complicated performance-enhancing design techniques such as the use of redundant logic to reduce fanout on critical nets or the instantiation of macros in HDL code to achieve high performance.

## I/O Modules

Each I/O on an SX device can be configured as an input, an output, a tristate output, or a bidirectional pin.

Even without the inclusion of dedicated I/O registers, these I/Os, in combination with array registers, can achieve clock-to-out (pad-to-pad) timing as fast as 3.7 ns. I/O cells that have embedded latches and flip-flops require instantiation in HDL code; this is a design complication not encountered in SX FPGAs. Fast pin-to-pin timing ensures that the device will have little trouble interfacing with any other device in the system, which in turn enables parallel design of system components and reduces overall design time.

### **Power Requirements**

The SX family supports 3.3 V operation and is designed to tolerate 5.0 V inputs. (Table 1-1). Power consumption is extremely low due to the very short distances signals are required to travel to complete a circuit. Power requirements are further reduced because of the small number of low-resistance antifuses in the path. The antifuse architecture does not require active circuitry to hold a charge (as do SRAM or EPROM), making it the lowest power architecture on the market.

| Denter                        |                  | V                | V                |                         | Maniana Outrat Daire |
|-------------------------------|------------------|------------------|------------------|-------------------------|----------------------|
| Device                        | V <sub>CCA</sub> | V <sub>CCI</sub> | V <sub>CCR</sub> | Maximum Input Tolerance | Maximum Output Drive |
| A54SX08<br>A54SX16<br>A54SX32 | 3.3 V            | 3.3 V            | 5.0 V            | 5.0 V                   | 3.3 V                |
| A54SX16-P*                    | 3.3 V            | 3.3 V            | 3.3 V            | 3.3 V                   | 3.3 V                |
|                               | 3.3 V            | 3.3 V            | 5.0 V            | 5.0 V                   | 3.3 V                |
|                               | 3.3 V            | 5.0 V            | 5.0 V            | 5.0 V                   | 5.0 V                |

**Note:** \*A54SX16-P has three different entries because it is capable of both a 3.3 V and a 5.0 V drive.





Figure 1-8 • Probe Setup

## Programming

Device programming is supported through Silicon Sculptor series of programmers. In particular, Silicon Sculptor II are compact, robust, single-site and multi-site device programmer for the PC.

With standalone software, Silicon Sculptor II allows concurrent programming of multiple units from the same PC, ensuring the fastest programming times possible. Each fuse is subsequently verified by Silicon Sculptor II to insure correct programming. In addition, integrity tests ensure that no extra fuses are programmed. Silicon Sculptor II also provides extensive hardware self-testing capability. The procedure for programming an SX device using Silicon Sculptor II are as follows:

- 1. Load the .AFM file
- 2. Select the device to be programmed
- 3. Begin programming

When the design is ready to go to production, Actel offers device volume-programming services either through distribution partners or via in-house programming from the factory.

For more details on programming SX devices, refer to the *Programming Antifuse Devices* application note and the *Silicon Sculptor II User's Guide*.

## **3.3 V / 5 V Operating Conditions** *Table 1-3* • Absolute Maximum Ratings<sup>1</sup>

| Symbol                        | Parameter                                     | Limits        | Units |
|-------------------------------|---|---------------|-------|
| V <sub>CCR</sub> <sup>2</sup> | DC Supply Voltage <sup>3</sup>                | -0.3 to + 6.0 | V     |
| V <sub>CCA</sub> <sup>2</sup> | DC Supply Voltage                             | -0.3 to + 4.0 | V     |
| V <sub>CCI</sub> <sup>2</sup> | DC Supply Voltage (A54SX08, A54SX16, A54SX32) | -0.3 to + 4.0 | V     |
| V <sub>CCI</sub> <sup>2</sup> | DC Supply Voltage (A54SX16P)                  | -0.3 to + 6.0 | V     |
| VI                            | Input Voltage                                 | -0.5 to + 5.5 | V     |
| V <sub>O</sub>                | Output Voltage                                | -0.5 to + 3.6 | V     |
| I <sub>IO</sub>               | I/O Source Sink Current <sup>3</sup>          | -30 to + 5.0  | mA    |
| T <sub>STG</sub>              | Storage Temperature                           | -65 to +150   | °C    |

Notes:

1. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rated conditions for extended periods may affect device reliability. Device should not be operated outside the Recommended Operating Conditions.

2.  $V_{CCR}$  in the A54SX16P must be greater than or equal to  $V_{CCI}$  during power-up and power-down sequences and during normal operation.

3. Device inputs are normally high impedance and draw extremely low current. However, when input voltage is greater than  $V_{CC}$  + 0.5 V or less than GND – 0.5 V, the internal protection diodes will forward-bias and can draw excessive current.

#### Table 1-4 • Recommended Operating Conditions

| Parameter                    | Commercial | Industrial  | Military    | Units            |
|------------------------------|------------|-------------|-------------|------------------|
| Temperature Range*           | 0 to + 70  | -40 to + 85 | –55 to +125 | °C               |
| 3.3 V Power Supply Tolerance | ±10        | ±10         | ±10         | %V <sub>CC</sub> |
| 5.0 V Power Supply Tolerance | ±5         | ±10         | ±10         | %V <sub>CC</sub> |

**Note:** \*Ambient temperature  $(T_A)$  is used for commercial and industrial; case temperature  $(T_C)$  is used for military.

#### Table 1-5Electrical Specifications

|                                 |  | Comme  | ercial                               | Indus                    | trial            |       |
|---------------------------------|--|--|--------------------------------------|--------------------------|------------------|-------|
| Symbol                          | Parameter  | Min.   | Max.                                 | Min.                     | Max.             | Units |
| V <sub>OH</sub>                 | $(I_{OH} = -20 \ \mu\text{A}) \ (CMOS)$<br>$(I_{OH} = -8 \ \text{mA}) \ (TTL)$ | (V <sub>CCI</sub> – 0.1)<br>2.4                    | V <sub>CCI</sub><br>V <sub>CCI</sub> | (V <sub>CCI</sub> – 0.1) | V <sub>CCI</sub> | V     |
|                                 | $(I_{OH} = -6 \text{ mA}) \text{ (TTL)}$                                       |  |                                      | 2.4                      | V <sub>CCI</sub> |       |
| V <sub>OL</sub>                 | (I <sub>OL</sub> = 20 μA) (CMOS)   |  | 0.10                                 |                          |                  | V     |
|                                 | $(I_{OL} = 12 \text{ mA}) \text{ (TTL)}$                                       |  | 0.50                                 |                          |                  |       |
|                                 | $(I_{OL} = 8 \text{ mA}) \text{ (TTL)}$  |  |                                      |                          | 0.50             |       |
| V <sub>IL</sub>                 |  |  | 0.8                                  |                          | 0.8              | V     |
| V <sub>IH</sub>                 |  | 2.0  |                                      | 2.0                      |                  | V     |
| t <sub>R</sub> , t <sub>F</sub> | Input Transition Time t <sub>R</sub> , t <sub>F</sub>                          |  | 50                                   |                          | 50               | ns    |
| C <sub>IO</sub>                 | C <sub>IO</sub> I/O Capacitance  |  | 10                                   |                          | 10               | pF    |
| I <sub>CC</sub>                 | Standby Current, I <sub>CC</sub>   |  | 4.0                                  |                          | 4.0              | mA    |
| I <sub>CC(D)</sub>              | I <sub>CC(D)</sub> I <sub>Dynamic</sub> V <sub>CC</sub> Supply Current         | See "Evaluating Power in SX Devices" on page 1-16. |                                      |                          |                  | -16.  |

# PCI Compliance for the SX Family

The SX family supports 3.3 V and 5.0 V PCI and is compliant with the PCI Local Bus Specification Rev. 2.1.

| Table 1-6 • | A54SX16P DC Specifications (5.0 V PCI Operation) |  |
|-------------|--|--|
|-------------|--|--|

| Symbol             | Parameter                                    | Condition                     | Min. | Max.           | Units |
|--------------------|--|-------------------------------|------|----------------|-------|
| V <sub>CCA</sub>   | Supply Voltage for Array                     |                               | 3.0  | 3.6            | V     |
| V <sub>CCR</sub>   | Supply Voltage required for Internal Biasing |                               | 4.75 | 5.25           | V     |
| V <sub>CCI</sub>   | Supply Voltage for I/Os                      |                               | 4.75 | 5.25           | V     |
| V <sub>IH</sub>    | Input High Voltage <sup>1</sup>              |                               | 2.0  | $V_{CC} + 0.5$ | V     |
| V <sub>IL</sub>    | Input Low Voltage <sup>1</sup>               |                               | -0.5 | 0.8            | V     |
| I <sub>IH</sub>    | Input High Leakage Current                   | V <sub>IN</sub> = 2.7         |      | 70             | μA    |
| IIL                | Input Low Leakage Current                    | V <sub>IN</sub> = 0.5         |      | -70            | μA    |
| V <sub>OH</sub>    | Output High Voltage                          | I <sub>OUT</sub> = -2 mA      | 2.4  |                | V     |
| V <sub>OL</sub>    | Output Low Voltage <sup>2</sup>              | I <sub>OUT</sub> = 3 mA, 6 mA |      | 0.55           | V     |
| C <sub>IN</sub>    | Input Pin Capacitance <sup>3</sup>           |                               |      | 10             | pF    |
| C <sub>CLK</sub>   | CLK Pin Capacitance                          |                               | 5    | 12             | pF    |
| C <sub>IDSEL</sub> | IDSEL Pin Capacitance <sup>4</sup>           |                               |      | 8              | pF    |

Notes:

1. Input leakage currents include hi-Z output leakage for all bidirectional buffers with tristate outputs.

2. Signals without pull-up resistors must have 3 mA low output current. Signals requiring pull-up must have 6 mA; the latter include, FRAME#, IRDY#, TRDY#, DEVSEL#, STOP#, SERR#, PERR#, LOCK#, and, when used, AD[63::32], C/BE[7::4]#, PAR64, REQ64#, and ACK64#.

3. Absolute maximum pin capacitance for a PCI input is 10 pF (except for CLK).

4. Lower capacitance on this input-only pin allows for non-resistive coupling to AD[xx].

# A54SX16P AC Specifications for (PCI Operation)

| Symbol                        | Parameter              | Condition                        | Min.                                 | Max.                | Units |
|-------------------------------|------------------------|----------------------------------|--------------------------------------|---------------------|-------|
| I <sub>OH(AC)</sub>           | Switching Current High | $0 < V_{OUT} \le 1.4^{1}$        | -44                                  |                     | mA    |
|                               |                        | $1.4 \le V_{OUT} < 2.4^{1, 2}$   | -44 + (V <sub>OUT</sub> - 1.4)/0.024 |                     | mA    |
|                               |                        | $3.1 < V_{OUT} < V_{CC}^{1, 3}$  |                                      | EQ 1-1 on page 1-11 |       |
|                               | (Test Point)           | $V_{OUT} = 3.1^{3}$              |                                      | -142                | mA    |
| I <sub>OL(AC)</sub> Switching | Switching Current High | $V_{OUT} \ge 2.2^{1}$            | 95                                   |                     | mA    |
|                               |                        | $2.2 > V_{OUT} > 0.55^{1}$       | V <sub>OUT</sub> /0.023              |                     |       |
|                               |                        | $0.71 > V_{OUT} > 0^{1, 3}$      |                                      | EQ 1-2 on page 1-11 | mA    |
|                               | (Test Point)           | $V_{OUT} = 0.71^{3}$             |                                      | 206                 | mA    |
| I <sub>CL</sub>               | Low Clamp Current      | $-5 < V_{IN} \leq -1$            | -25 + (V <sub>IN</sub> + 1)/0.015    |                     | mA    |
| slew <sub>R</sub>             | Output Rise Slew Rate  | 0.4 V to 2.4 V load <sup>4</sup> | 1                                    | 5                   | V/ns  |
| slew <sub>F</sub>             | Output Fall Slew Rate  | 2.4 V to 0.4 V load <sup>4</sup> | 1                                    | 5                   | V/ns  |

#### Table 1-7 A54SX16P AC Specifications for (PCI Operation)

#### Notes:

1. Refer to the V/I curves in Figure 1-9 on page 1-11. Switching current characteristics for REQ# and GNT# are permitted to be one half of that specified here; i.e., half-size output drivers may be used on these signals. This specification does not apply to CLK and RST#, which are system outputs. "Switching Current High" specifications are not relevant to SERR#, INTA#, INTB#, INTC#, and INTD#, which are open drain outputs.

2. Note that this segment of the minimum current curve is drawn from the AC drive point directly to the DC drive point rather than toward the voltage rail (as is done in the pull-down curve). This difference is intended to allow for an optional N-channel pull-up.

3. Maximum current requirements must be met as drivers pull beyond the last step voltage. Equations defining these maximums (A and B) are provided with the respective diagrams in Figure 1-9 on page 1-11. The equation defined maxima should be met by design. In order to facilitate component testing, a maximum current test point is defined for each side of the output driver.

4. This parameter is to be interpreted as the cumulative edge rate across the specified range, rather than the instantaneous rate at any point within the transition range. The specified load (diagram below) is optional; i.e., the designer may elect to meet this parameter with an unloaded output per revision 2.0 of the PCI Local Bus Specification. However, adherence to both maximum and minimum parameters is now required (the maximum is no longer simply a guideline). Since adherence to the maximum slew rate was not required prior to revision 2.1 of the specification, there may be components in the market for some time that have faster edge rates; therefore, motherboard designers must bear in mind that rise and fall times faster than this specification could occur, and should ensure that signal integrity modeling accounts for this. Rise slew rate does not apply to open drain outputs.



# **Evaluating Power in SX Devices**

A critical element of system reliability is the ability of electronic devices to safely dissipate the heat generated during operation. The thermal characteristics of a circuit depend on the device and package used, the operating temperature, the operating current, and the system's ability to dissipate heat.

You should complete a power evaluation early in the design process to help identify potential heat-related problems in the system and to prevent the system from exceeding the device's maximum allowed junction temperature.

The actual power dissipated by most applications is significantly lower than the power the package can dissipate. However, a thermal analysis should be performed for all projects. To perform a power evaluation, follow these steps:

- 1. Estimate the power consumption of the application.
- 2. Calculate the maximum power allowed for the device and package.
- 3. Compare the estimated power and maximum power values.

## **Estimating Power Consumption**

The total power dissipation for the SX family is the sum of the DC power dissipation and the AC power dissipation. Use EQ 1-5 to calculate the estimated power consumption of your application.

$$P_{Total} = P_{DC} + P_{AC}$$

р

х

у

r<sub>1</sub>

fn

fp

f<sub>s1</sub>

## **DC** Power Dissipation

The power due to standby current is typically a small component of the overall power. The Standby power is shown in Table 1-12 for commercial, worst-case conditions (70°C).

| Table 1-12 | • Sta | ndby Pov | ver |
|------------|-------|----------|-----|
|------------|-------|----------|-----|

| I <sub>cc</sub> | V <sub>cc</sub> | Power   |
|-----------------|-----------------|---------|
| 4 mA            | 3.6 V           | 14.4 mW |

The DC power dissipation is defined in EO 1-6.

 $P_{DC} = (I_{standby}) \times V_{CCA} + (I_{standby}) \times V_{CCR} +$  $(I_{standbv}) \times V_{CCI} + xV_{OL} \times I_{OL} + y(V_{CCI} - V_{OH}) \times V_{OH}$ 

EQ 1-6

## **AC Power Dissipation**

The power dissipation of the SX Family is usually dominated by the dynamic power dissipation. Dynamic power dissipation is a function of frequency, equivalent capacitance, and power supply voltage. The AC power dissipation is defined in EQ 1-7 and EQ 1-8.

EQ 1-7

 $P_{AC} = V_{CCA}^2 \times [(m \times C_{EOM} \times f_m)_{Module} +$  $(n \times C_{EOI} \times f_n)_{Input Buffer} + (p \times (C_{EOO} + C_L) \times f_p)_{Output Buffer} +$  $(0.5 \times (q_1 \times C_{EQCR} \times f_{q1}) + (r_1 \times f_{q1}))_{RCLKA} +$  $(0.5 \times (q2 \times CEQCR \times f_{q2}) + (r2 \times f_{q2}))RCLKB +$  $(0.5 \times (s_1 \times C_{EOHV} \times f_{s1}) + (C_{EOHF} \times f_{s1}))_{HCLK}]$ 

EQ 1-8

## **Definition of Terms Used in Formula**

| m | = | Number of logic modules switching at f <sub>m</sub> |
|---|---|---|
| n | = | Number of input buffers switching at f <sub>p</sub> |

- = Number of input buffers switching at f<sub>n</sub>
- Number of output buffers switching at fp =
- Number of clock loads on the first routed array  $q_1$ clock
- Number of clock loads on the second routed array =  $q_2$ clock
  - = Number of I/Os at logic low
  - Number of I/Os at logic high =
  - = Fixed capacitance due to first routed array clock
- Fixed capacitance due to second routed array = r<sub>2</sub> clock
- Number of clock loads on the dedicated array = s<sub>1</sub> clock

$$C_{EQM}$$
 = Equivalent capacitance of logic modules in pF

- Equivalent capacitance of input buffers in pF C<sub>EQI</sub> =
- Equivalent capacitance of output buffers in pF  $C_{EOO} =$
- Equivalent capacitance of routed array clock in pF  $C_{EOCR} =$
- Variable capacitance of dedicated array clock  $C_{EOHV} =$
- Fixed capacitance of dedicated array clock  $C_{EOHF} =$
- C = Output lead capacitance in pF
- Average logic module switching rate in MHz fm =
  - = Average input buffer switching rate in MHz
  - = Average output buffer switching rate in MHz
- = Average first routed array clock rate in MHz f<sub>q1</sub>
- Average second routed array clock rate in MHz f<sub>q2</sub> =
  - = Average dedicated array clock rate in MHz

Table 1-13 shows capacitance values for various devices.

|                        | A54SX08 | A54SX16 | A54SX16P | A54SX32 |
|------------------------|---------|---------|----------|---------|
| C <sub>EQM</sub> (pF)  | 4.0     | 4.0     | 4.0      | 4.0     |
| C <sub>EQI</sub> (pF)  | 3.4     | 3.4     | 3.4      | 3.4     |
| C <sub>EQO</sub> (pF)  | 4.7     | 4.7     | 4.7      | 4.7     |
| C <sub>EQCR</sub> (pF) | 1.6     | 1.6     | 1.6      | 1.6     |
| C <sub>EQHV</sub>      | 0.615   | 0.615   | 0.615    | 0.615   |
| C <sub>EQHF</sub>      | 60      | 96      | 96       | 140     |
| r <sub>1</sub> (pF)    | 87      | 138     | 138      | 171     |
| r <sub>2</sub> (pF)    | 87      | 138     | 138      | 171     |

 Table 1-13
 Capacitance Values for Devices

#### Table 1-14 • Power Consumption Guidelines

## Guidelines for Calculating Power Consumption

The power consumption guidelines are meant to represent worst-case scenarios so that they can be generally used to predict the upper limits of power dissipation. These guidelines are shown in Table 1-14.

## **Sample Power Calculation**

One of the designs used to characterize the SX family was a 528 bit serial-in, serial-out shift register. The design utilized 100 percent of the dedicated flip-flops of an A54SX16P device. A pattern of 0101... was clocked into the device at frequencies ranging from 1 MHz to 200 MHz. Shifting in a series of 0101... caused 50 percent of the flip-flops to toggle from low to high at every clock cycle.

| Description   | Power Consumption Guideline |
|---|-----------------------------|
| Logic Modules (m)   | 20% of modules              |
| Inputs Switching (n)                                      | # inputs/4                  |
| Outputs Switching (p)                                     | # outputs/4                 |
| First Routed Array Clock Loads (q <sub>1</sub> )          | 20% of register cells       |
| Second Routed Array Clock Loads (q <sub>2</sub> )         | 20% of register cells       |
| Load Capacitance (C <sub>L</sub> )                        | 35 pF                       |
| Average Logic Module Switching Rate (f <sub>m</sub> )     | f/10                        |
| Average Input Switching Rate (f <sub>n</sub> )            | f/5                         |
| Average Output Switching Rate (f <sub>p</sub> )           | f/10                        |
| Average First Routed Array Clock Rate (f <sub>q1</sub> )  | f/2                         |
| Average Second Routed Array Clock Rate (f <sub>q2</sub> ) | f/2                         |
| Average Dedicated Array Clock Rate (f <sub>s1</sub> )     | f                           |
| Dedicated Clock Array Clock Loads (s <sub>1</sub> )       | 20% of regular modules      |

Follow the steps below to estimate power consumption. The values provided for the sample calculation below are for the shift register design above. This method for estimating power consumption is conservative and the actual power consumption of your design may be less than the estimated power consumption.

The total power dissipation for the SX family is the sum of the AC power dissipation and the DC power dissipation.

$$P_{Total} = P_{AC}$$
 (dynamic power) +  $P_{DC}$  (static power)

EQ 1-9

### **AC Power Dissipation**

 $P_{AC} = P_{Module} + P_{RCLKA Net} + P_{RCLKB Net} + P_{HCLK Net} + P_{Output Buffer} + P_{Input Buffer}$ 

$$\begin{split} P_{AC} &= V_{CCA}^2 \times [(m \times C_{EQM} \times f_m)_{Module} + \\ (n \times C_{EQI} \times f_n)_{Input Buffer} + (p \times (C_{EQO} + C_L) \times f_p)_{Output Buffer} + \\ (0.5 & (q_1 \times C_{EQCR} \times f_{q1}) + (r_1 \times f_{q1}))_{RCLKA} + \\ (0.5 & (q_2 \times C_{EQCR} \times f_{q2}) + (r_2 \times f_{q2}))_{RCLKB} + \\ (0.5 & (s_1 \times C_{EQHV} \times f_{s1}) + (C_{EQHF} \times f_{s1}))_{HCLK}] \end{split}$$

EQ 1-11

#### Table 1-15 • Package Thermal Characteristics

| Package Type  | Pin Count | θ <sub>jc</sub> | θ <sub>ja</sub><br>Still Air | $^{	heta_{ja}}$ 300 ft/min. | Units |
|---|-----------|-----------------|------------------------------|-----------------------------|-------|
| Plastic Leaded Chip Carrier (PLCC)                  | 84        | 12              | 32                           | 22                          | °C/W  |
| Thin Quad Flat Pack (TQFP)                          | 144       | 11              | 32                           | 24                          | °C/W  |
| Thin Quad Flat Pack (TQFP)                          | 176       | 11              | 28                           | 21                          | °C/W  |
| Very Thin Quad Flatpack (VQFP)                      | 100       | 10              | 38                           | 32                          | °C/W  |
| Plastic Quad Flat Pack (PQFP) without Heat Spreader | 208       | 8               | 30                           | 23                          | °C/W  |
| Plastic Quad Flat Pack (PQFP) with Heat Spreader    | 208       | 3.8             | 20                           | 17                          | °C/W  |
| Plastic Ball Grid Array (PBGA)                      | 272       | 3               | 20                           | 14.5                        | °C/W  |
| Plastic Ball Grid Array (PBGA)                      | 313       | 3               | 23                           | 17                          | °C/W  |
| Plastic Ball Grid Array (PBGA)                      | 329       | 3               | 18                           | 13.5                        | °C/W  |
| Fine Pitch Ball Grid Array (FBGA)                   | 144       | 3.8             | 38.8                         | 26.7                        | °C/W  |

Note: SX08 does not have a heat spreader.

### Table 1-16 • Temperature and Voltage Derating Factors\*

|                  | Junction Temperature |      |      |      |      |      |      |  |  |
|------------------|----------------------|------|------|------|------|------|------|--|--|
| V <sub>CCA</sub> | -55                  | -40  | 0    | 25   | 70   | 85   | 125  |  |  |
| 3.0              | 0.75                 | 0.78 | 0.87 | 0.89 | 1.00 | 1.04 | 1.16 |  |  |
| 3.3              | 0.70                 | 0.73 | 0.82 | 0.83 | 0.93 | 0.97 | 1.08 |  |  |
| 3.6              | 0.66                 | 0.69 | 0.77 | 0.78 | 0.87 | 0.92 | 1.02 |  |  |

**Note:** \*Normalized to worst-case commercial,  $T_J = 70^{\circ}$ C,  $V_{CCA} = 3.0 V$ 

#### Table 1-18 A54SX16 Timing Characteristics (Continued)

| (Worst-Case Commercial Conditions, V | / <sub>CCR</sub> = 4.75 V, V <sub>CC</sub> | <sub>CA</sub> ,V <sub>CCI</sub> = 3.0 V, T <sub>J</sub> = 70°C) |
|--------------------------------------|--|---|
|--------------------------------------|--|---|

|                    |   |      | Speed | '–2' Speed |      | '–1' Speed |      | 'Std' Speed |      |       |  |
|--------------------|---|------|-------|------------|------|------------|------|-------------|------|-------|--|
| Parameter          | Description   | Min. | Max.  | Min.       | Max. | Min.       | Max. | Min.        | Max. | Units |  |
| Dedicated (        | Hardwired) Array Clock Network                          |      |       |            |      |            |      |             |      |       |  |
| t <sub>HCKH</sub>  | Input LOW to HIGH (pad to R-Cell input)                 |      | 1.2   |            | 1.4  |            | 1.5  |             | 1.8  | ns    |  |
| t <sub>HCKL</sub>  | Input HIGH to LOW (pad to R-Cell input)                 |      | 1.2   |            | 1.4  |            | 1.6  |             | 1.9  | ns    |  |
| t <sub>HPWH</sub>  | Minimum Pulse Width HIGH                                | 1.4  |       | 1.6        |      | 1.8        |      | 2.1         |      | ns    |  |
| t <sub>HPWL</sub>  | Minimum Pulse Width LOW                                 | 1.4  |       | 1.6        |      | 1.8        |      | 2.1         |      | ns    |  |
| t <sub>HCKSW</sub> | Maximum Skew  |      | 0.2   |            | 0.2  |            | 0.3  |             | 0.3  | ns    |  |
| t <sub>HP</sub>    | Minimum Period  | 2.7  |       | 3.1        |      | 3.6        |      | 4.2         |      | ns    |  |
| f <sub>HMAX</sub>  | Maximum Frequency                                       |      | 350   |            | 320  |            | 280  |             | 240  | MHz   |  |
| Routed Arra        | ay Clock Networks                                       |      |       |            |      |            |      |             |      |       |  |
| t <sub>RCKH</sub>  | Input LOW to HIGH (light load)<br>(pad to R-Cell input) |      | 1.6   |            | 1.8  |            | 2.1  |             | 2.5  | ns    |  |
| t <sub>RCKL</sub>  | Input HIGH to LOW (light load)<br>(pad to R-Cell input) |      | 1.8   |            | 2.0  |            | 2.3  |             | 2.7  | ns    |  |
| t <sub>RCKH</sub>  | Input LOW to HIGH (50% load)<br>(pad to R-Cell input)   |      | 1.8   |            | 2.1  |            | 2.5  |             | 2.8  | ns    |  |
| t <sub>RCKL</sub>  | Input HIGH to LOW (50% load)<br>(pad to R-Cell input)   |      | 2.0   |            | 2.2  |            | 2.5  |             | 3.0  | ns    |  |
| t <sub>RCKH</sub>  | Input LOW to HIGH (100% load)<br>(pad to R-Cell input)  |      | 1.8   |            | 2.1  |            | 2.4  |             | 2.8  | ns    |  |
| t <sub>RCKL</sub>  | Input HIGH to LOW (100% load)<br>(pad to R-Cell input)  |      | 2.0   |            | 2.2  |            | 2.5  |             | 3.0  | ns    |  |
| t <sub>RPWH</sub>  | Min. Pulse Width HIGH                                   | 2.1  |       | 2.4        |      | 2.7        |      | 3.2         |      | ns    |  |
| t <sub>RPWL</sub>  | Min. Pulse Width LOW                                    | 2.1  |       | 2.4        |      | 2.7        |      | 3.2         |      | ns    |  |
| t <sub>RCKSW</sub> | Maximum Skew (light load)                               |      | 0.5   |            | 0.5  |            | 0.5  |             | 0.7  | ns    |  |
| t <sub>RCKSW</sub> | Maximum Skew (50% load)                                 |      | 0.5   |            | 0.6  |            | 0.7  |             | 0.8  | ns    |  |
| t <sub>RCKSW</sub> | Maximum Skew (100% load)                                |      | 0.5   |            | 0.6  |            | 0.7  |             | 0.8  | ns    |  |
| TTL Output         | Module Timing <sup>3</sup>                              |      |       |            |      |            |      |             |      |       |  |
| t <sub>DLH</sub>   | Data-to-Pad LOW to HIGH                                 |      | 1.6   |            | 1.9  |            | 2.1  |             | 2.5  | ns    |  |
| t <sub>DHL</sub>   | Data-to-Pad HIGH to LOW                                 |      | 1.6   |            | 1.9  |            | 2.1  |             | 2.5  | ns    |  |
| t <sub>ENZL</sub>  | Enable-to-Pad, Z to L                                   |      | 2.1   |            | 2.4  |            | 2.8  |             | 3.2  | ns    |  |
| t <sub>ENZH</sub>  | Enable-to-Pad, Z to H                                   |      | 2.3   |            | 2.7  |            | 3.1  |             | 3.6  | ns    |  |
| t <sub>ENLZ</sub>  | Enable-to-Pad, L to Z                                   |      | 1.4   |            | 1.7  |            | 1.9  |             | 2.2  | ns    |  |
| t <sub>ENHZ</sub>  | Enable-to-Pad, H to Z                                   |      | 1.3   |            | 1.5  |            | 1.7  |             | 2.0  | ns    |  |

Notes:

1. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.

2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual worst-case performance. Post-route timing is based on actual routing delay measurements performed on the device prior to shipment.

3. Delays based on 35 pF loading, except  $t_{ENZL}$  and  $t_{ENZH}$ . For  $t_{ENZL}$  and  $t_{ENZH}$ , the loading is 5 pF.

## A54SX16P Timing Characteristics

Table 1-19 • A54SX16P Timing Characteristics

(Worst-Case Commercial Conditions, V<sub>CCR</sub> = 4.75 V, V<sub>CCA</sub>, V<sub>CCI</sub> = 3.0 V, T<sub>J</sub> = 70°C)

|                     |                                      | '-3' 9 | 5peed | '-2' Speed |      | '–1' Speed |      | 'Std' Speed |      |       |  |
|---------------------|--------------------------------------|--------|-------|------------|------|------------|------|-------------|------|-------|--|
| Parameter           | Description                          | Min.   | Max.  | Min.       | Max. | Min.       | Max. | Min.        | Max. | Units |  |
| C-Cell Propa        | agation Delays <sup>1</sup>          |        |       |            |      |            |      |             |      |       |  |
| t <sub>PD</sub>     | Internal Array Module                |        | 0.6   |            | 0.7  |            | 0.8  |             | 0.9  | ns    |  |
| Predicted R         | outing Delays <sup>2</sup>           |        |       |            |      |            |      |             |      |       |  |
| t <sub>DC</sub>     | FO = 1 Routing Delay, Direct Connect |        | 0.1   |            | 0.1  |            | 0.1  |             | 0.1  | ns    |  |
| t <sub>FC</sub>     | FO = 1 Routing Delay, Fast Connect   |        | 0.3   |            | 0.4  |            | 0.4  |             | 0.5  | ns    |  |
| t <sub>RD1</sub>    | FO = 1 Routing Delay                 |        | 0.3   |            | 0.4  |            | 0.4  |             | 0.5  | ns    |  |
| t <sub>RD2</sub>    | FO = 2 Routing Delay                 |        | 0.6   |            | 0.7  |            | 0.8  |             | 0.9  | ns    |  |
| t <sub>RD3</sub>    | FO = 3 Routing Delay                 |        | 0.8   |            | 0.9  |            | 1.0  |             | 1.2  | ns    |  |
| t <sub>RD4</sub>    | FO = 4 Routing Delay                 |        | 1.0   |            | 1.2  |            | 1.4  |             | 1.6  | ns    |  |
| t <sub>RD8</sub>    | FO = 8 Routing Delay                 |        | 1.9   |            | 2.2  |            | 2.5  |             | 2.9  | ns    |  |
| t <sub>RD12</sub>   | FO = 12 Routing Delay                |        | 2.8   |            | 3.2  |            | 3.7  |             | 4.3  | ns    |  |
| <b>R-Cell Timin</b> | <u>.</u><br>1g                       |        |       |            |      |            |      |             |      |       |  |
| t <sub>RCO</sub>    | Sequential Clock-to-Q                |        | 0.9   |            | 1.1  |            | 1.3  |             | 1.4  | ns    |  |
| t <sub>CLR</sub>    | Asynchronous Clear-to-Q              |        | 0.5   |            | 0.6  |            | 0.7  |             | 0.8  | ns    |  |
| t <sub>PRESET</sub> | Asynchronous Preset-to-Q             |        | 0.7   |            | 0.8  |            | 0.9  |             | 1.0  | ns    |  |
| t <sub>SUD</sub>    | Flip-Flop Data Input Set-Up          | 0.5    |       | 0.5        |      | 0.7        |      | 0.8         |      | ns    |  |
| t <sub>HD</sub>     | Flip-Flop Data Input Hold            | 0.0    |       | 0.0        |      | 0.0        |      | 0.0         |      | ns    |  |
| t <sub>WASYN</sub>  | Asynchronous Pulse Width             | 1.4    |       | 1.6        |      | 1.8        |      | 2.1         |      | ns    |  |
| Input Modu          | le Propagation Delays                |        |       |            |      |            |      |             |      |       |  |
| t <sub>INYH</sub>   | Input Data Pad-to-Y HIGH             |        | 1.5   |            | 1.7  |            | 1.9  |             | 2.2  | ns    |  |
| t <sub>INYL</sub>   | Input Data Pad-to-Y LOW              |        | 1.5   |            | 1.7  |            | 1.9  |             | 2.2  | ns    |  |
| Predicted Ir        | nput Routing Delays <sup>2</sup>     |        |       |            |      |            |      |             |      |       |  |
| t <sub>IRD1</sub>   | FO = 1 Routing Delay                 |        | 0.3   |            | 0.4  |            | 0.4  |             | 0.5  | ns    |  |
| t <sub>IRD2</sub>   | FO = 2 Routing Delay                 |        | 0.6   |            | 0.7  |            | 0.8  |             | 0.9  | ns    |  |
| t <sub>IRD3</sub>   | FO = 3 Routing Delay                 |        | 0.8   |            | 0.9  |            | 1.0  |             | 1.2  | ns    |  |
| t <sub>IRD4</sub>   | FO = 4 Routing Delay                 |        | 1.0   |            | 1.2  |            | 1.4  |             | 1.6  | ns    |  |
| t <sub>IRD8</sub>   | FO = 8 Routing Delay                 |        | 1.9   |            | 2.2  |            | 2.5  |             | 2.9  | ns    |  |
| t <sub>IRD12</sub>  | FO = 12 Routing Delay                |        | 2.8   |            | 3.2  |            | 3.7  |             | 4.3  | ns    |  |

Note:

1. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.

2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual worst-case performance. Post-route timing is based on actual routing delay measurements performed on the device prior to shipment.

3. Delays based on 10 pF loading.

| 84-Pin PLCC |                     |  |  |  |  |
|-------------|---------------------|--|--|--|--|
| Pin Number  | A54SX08<br>Function |  |  |  |  |
| 1           | V <sub>CCR</sub>    |  |  |  |  |
| 2           | GND                 |  |  |  |  |
| 3           | V <sub>CCA</sub>    |  |  |  |  |
| 4           | PRA, I/O            |  |  |  |  |
| 5           | I/O                 |  |  |  |  |
| 6           | I/O                 |  |  |  |  |
| 7           | V <sub>CCI</sub>    |  |  |  |  |
| 8           | I/O                 |  |  |  |  |
| 9           | I/O                 |  |  |  |  |
| 10          | I/O                 |  |  |  |  |
| 11          | TCK, I/O            |  |  |  |  |
| 12          | TDI, I/O            |  |  |  |  |
| 13          | I/O                 |  |  |  |  |
| 14          | I/O                 |  |  |  |  |
| 15          | I/O                 |  |  |  |  |
| 16          | TMS                 |  |  |  |  |
| 17          | I/O                 |  |  |  |  |
| 18          | I/O                 |  |  |  |  |
| 19          | I/O                 |  |  |  |  |
| 20          | I/O                 |  |  |  |  |
| 21          | I/O                 |  |  |  |  |
| 22          | I/O                 |  |  |  |  |
| 23          | I/O                 |  |  |  |  |
| 24          | I/O                 |  |  |  |  |
| 25          | I/O                 |  |  |  |  |
| 26          | I/O                 |  |  |  |  |
| 27          | GND                 |  |  |  |  |
| 28          | V <sub>CCI</sub>    |  |  |  |  |
| 29          | I/O                 |  |  |  |  |
| 30          | I/O                 |  |  |  |  |
| 31          | I/O                 |  |  |  |  |
| 32          | I/O                 |  |  |  |  |
| 33          | I/O                 |  |  |  |  |
| 34          | I/O                 |  |  |  |  |
| 35          | I/O                 |  |  |  |  |

| 84-Pin PLCC |                     |  |  |
|-------------|---------------------|--|--|
| Pin Number  | A54SX08<br>Function |  |  |
| 36          | I/O                 |  |  |
| 37          | I/O                 |  |  |
| 38          | I/O                 |  |  |
| 39          | I/O                 |  |  |
| 40          | PRB, I/O            |  |  |
| 41          | V <sub>CCA</sub>    |  |  |
| 42          | GND                 |  |  |
| 43          | V <sub>CCR</sub>    |  |  |
| 44          | I/O                 |  |  |
| 45          | HCLK                |  |  |
| 46          | I/O                 |  |  |
| 47          | I/O                 |  |  |
| 48          | I/O                 |  |  |
| 49          | I/O                 |  |  |
| 50          | I/O                 |  |  |
| 51          | I/O                 |  |  |
| 52          | TDO, I/O            |  |  |
| 53          | I/O                 |  |  |
| 54          | I/O                 |  |  |
| 55          | I/O                 |  |  |
| 56          | I/O                 |  |  |
| 57          | I/O                 |  |  |
| 58          | I/O                 |  |  |
| 59          | V <sub>CCA</sub>    |  |  |
| 60          | V <sub>CCI</sub>    |  |  |
| 61          | GND                 |  |  |
| 62          | I/O                 |  |  |
| 63          | I/O                 |  |  |
| 64          | I/O                 |  |  |
| 65          | I/O                 |  |  |
| 66          | I/O                 |  |  |
| 67          | I/O                 |  |  |
| 68          | V <sub>CCA</sub>    |  |  |
| 69          | GND                 |  |  |
| 70          | I/O                 |  |  |

| 84-Pin PLCC |                     |  |  |  |  |
|-------------|---------------------|--|--|--|--|
| Pin Number  | A54SX08<br>Function |  |  |  |  |
| 71          | I/O                 |  |  |  |  |
| 72          | I/O                 |  |  |  |  |
| 73          | I/O                 |  |  |  |  |
| 74          | I/O                 |  |  |  |  |
| 75          | I/O                 |  |  |  |  |
| 76          | I/O                 |  |  |  |  |
| 77          | I/O                 |  |  |  |  |
| 78          | I/O                 |  |  |  |  |
| 79          | I/O                 |  |  |  |  |
| 80          | I/O                 |  |  |  |  |
| 81          | I/O                 |  |  |  |  |
| 82          | I/O                 |  |  |  |  |
| 83          | CLKA                |  |  |  |  |
| 84          | CLKB                |  |  |  |  |

|         | Actel      |  |
|---------|------------|--|
| 54SX Fa | mily FPGAs |  |

|            | 208-Pi              | n PQFP                           |                     | 208-Pin PQFP |                     |                                  |                     |  |  |  |  |
|------------|---------------------|----------------------------------|---------------------|--------------|---------------------|----------------------------------|---------------------|--|--|--|--|
| Pin Number | A54SX08<br>Function | A54SX16,<br>A54SX16P<br>Function | A54SX32<br>Function | Pin Number   | A54SX08<br>Function | A54SX16,<br>A54SX16P<br>Function | A54SX32<br>Function |  |  |  |  |
| 73         | NC                  | I/O                              | I/O                 | 109          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 74         | I/O                 | I/O                              | I/O                 | 110          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 75         | NC                  | I/O                              | I/O                 | 111          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 76         | PRB, I/O            | PRB, I/O                         | PRB, I/O            | 112          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 77         | GND                 | GND                              | GND                 | 113          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 78         | V <sub>CCA</sub>    | V <sub>CCA</sub>                 | V <sub>CCA</sub>    | 114          | V <sub>CCA</sub>    | V <sub>CCA</sub>                 | V <sub>CCA</sub>    |  |  |  |  |
| 79         | GND                 | GND                              | GND                 | 115          | V <sub>CCI</sub>    | V <sub>CCI</sub>                 | V <sub>CCI</sub>    |  |  |  |  |
| 80         | V <sub>CCR</sub>    | V <sub>CCR</sub>                 | V <sub>CCR</sub>    | 116          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 81         | I/O                 | I/O                              | I/O                 | 117          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 82         | HCLK                | HCLK                             | HCLK                | 118          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 83         | I/O                 | I/O                              | I/O                 | 119          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 84         | I/O                 | I/O                              | I/O                 | 120          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 85         | NC                  | I/O                              | I/O                 | 121          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 86         | I/O                 | I/O                              | I/O                 | 122          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 87         | I/O                 | I/O                              | I/O                 | 123          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 88         | NC                  | I/O                              | I/O                 | 124          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 89         | I/O                 | I/O                              | I/O                 | 125          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 90         | I/O                 | I/O                              | I/O                 | 126          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 91         | NC                  | I/O                              | I/O                 | 127          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 92         | I/O                 | I/O                              | I/O                 | 128          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 93         | I/O                 | I/O                              | I/O                 | 129          | GND                 | GND                              | GND                 |  |  |  |  |
| 94         | NC                  | I/O                              | I/O                 | 130          | V <sub>CCA</sub>    | V <sub>CCA</sub>                 | V <sub>CCA</sub>    |  |  |  |  |
| 95         | I/O                 | I/O                              | I/O                 | 131          | GND                 | GND                              | GND                 |  |  |  |  |
| 96         | I/O                 | I/O                              | I/O                 | 132          | V <sub>CCR</sub>    | V <sub>CCR</sub>                 | V <sub>CCR</sub>    |  |  |  |  |
| 97         | NC                  | I/O                              | I/O                 | 133          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 98         | V <sub>CCI</sub>    | V <sub>CCI</sub>                 | V <sub>CCI</sub>    | 134          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 99         | I/O                 | I/O                              | I/O                 | 135          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 100        | I/O                 | I/O                              | I/O                 | 136          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 101        | I/O                 | I/O                              | I/O                 | 137          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 102        | I/O                 | I/O                              | I/O                 | 138          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 103        | TDO, I/O            | TDO, I/O                         | TDO, I/O            | 139          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 104        | I/O                 | I/O                              | I/O                 | 140          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 105        | GND                 | GND                              | GND                 | 141          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 106        | NC                  | I/O                              | I/O                 | 142          | I/O                 | I/O                              | I/O                 |  |  |  |  |
| 107        | I/O                 | I/O                              | I/O                 | 143          | NC                  | I/O                              | I/O                 |  |  |  |  |
| 108        | NC                  | I/O                              | I/O                 | 144          | I/O                 | I/O                              | I/O                 |  |  |  |  |

**Note:** \* Note that Pin 65 in the A54SX32—PQ208 is a no connect (NC).



| 144-Pin TQFP |                     |                      | 144-Pin TQFP        |            |                     |                      |                     |
|--------------|---------------------|----------------------|---------------------|------------|---------------------|----------------------|---------------------|
| Pin Number   | A54SX08<br>Function | A54SX16P<br>Function | A54SX32<br>Function | Pin Number | A54SX08<br>Function | A54SX16P<br>Function | A54SX32<br>Function |
| 73           | GND                 | GND                  | GND                 | 109        | GND                 | GND                  | GND                 |
| 74           | I/O                 | I/O                  | I/O                 | 110        | I/O                 | I/O                  | I/O                 |
| 75           | I/O                 | I/O                  | I/O                 | 111        | I/O                 | I/O                  | I/O                 |
| 76           | I/O                 | I/O                  | I/O                 | 112        | I/O                 | I/O                  | I/O                 |
| 77           | I/O                 | I/O                  | I/O                 | 113        | I/O                 | I/O                  | I/O                 |
| 78           | I/O                 | I/O                  | I/O                 | 114        | I/O                 | I/O                  | I/O                 |
| 79           | V <sub>CCA</sub>    | V <sub>CCA</sub>     | V <sub>CCA</sub>    | 115        | V <sub>CCI</sub>    | V <sub>CCI</sub>     | V <sub>CCI</sub>    |
| 80           | V <sub>CCI</sub>    | V <sub>CCI</sub>     | V <sub>CCI</sub>    | 116        | I/O                 | I/O                  | I/O                 |
| 81           | GND                 | GND                  | GND                 | 117        | I/O                 | I/O                  | I/O                 |
| 82           | I/O                 | I/O                  | I/O                 | 118        | I/O                 | I/O                  | I/O                 |
| 83           | I/O                 | I/O                  | I/O                 | 119        | I/O                 | I/O                  | I/O                 |
| 84           | I/O                 | I/O                  | I/O                 | 120        | I/O                 | I/O                  | I/O                 |
| 85           | I/O                 | I/O                  | I/O                 | 121        | I/O                 | I/O                  | I/O                 |
| 86           | I/O                 | I/O                  | I/O                 | 122        | I/O                 | I/O                  | I/O                 |
| 87           | I/O                 | I/O                  | I/O                 | 123        | I/O                 | I/O                  | I/O                 |
| 88           | I/O                 | I/O                  | I/O                 | 124        | I/O                 | I/O                  | I/O                 |
| 89           | V <sub>CCA</sub>    | V <sub>CCA</sub>     | V <sub>CCA</sub>    | 125        | CLKA                | CLKA                 | CLKA                |
| 90           | V <sub>CCR</sub>    | V <sub>CCR</sub>     | V <sub>CCR</sub>    | 126        | CLKB                | CLKB                 | CLKB                |
| 91           | I/O                 | I/O                  | I/O                 | 127        | V <sub>CCR</sub>    | V <sub>CCR</sub>     | V <sub>CCR</sub>    |
| 92           | I/O                 | I/O                  | I/O                 | 128        | GND                 | GND                  | GND                 |
| 93           | I/O                 | I/O                  | I/O                 | 129        | V <sub>CCA</sub>    | V <sub>CCA</sub>     | V <sub>CCA</sub>    |
| 94           | I/O                 | I/O                  | I/O                 | 130        | I/O                 | I/O                  | I/O                 |
| 95           | I/O                 | I/O                  | I/O                 | 131        | Pra, I/O            | PRA, I/O             | PRA, I/O            |
| 96           | I/O                 | I/O                  | I/O                 | 132        | I/O                 | I/O                  | I/O                 |
| 97           | I/O                 | I/O                  | I/O                 | 133        | I/O                 | I/O                  | I/O                 |
| 98           | V <sub>CCA</sub>    | V <sub>CCA</sub>     | V <sub>CCA</sub>    | 134        | I/O                 | I/O                  | I/O                 |
| 99           | GND                 | GND                  | GND                 | 135        | I/O                 | I/O                  | I/O                 |
| 100          | I/O                 | I/O                  | I/O                 | 136        | I/O                 | I/O                  | I/O                 |
| 101          | GND                 | GND                  | GND                 | 137        | I/O                 | I/O                  | I/O                 |
| 102          | V <sub>CCI</sub>    | V <sub>CCI</sub>     | V <sub>CCI</sub>    | 138        | I/O                 | I/O                  | I/O                 |
| 103          | I/O                 | I/O                  | I/O                 | 139        | I/O                 | I/O                  | I/O                 |
| 104          | I/O                 | I/O                  | I/O                 | 140        | V <sub>CCI</sub>    | V <sub>CCI</sub>     | V <sub>CCI</sub>    |
| 105          | I/O                 | I/O                  | I/O                 | 141        | I/O                 | I/O                  | I/O                 |
| 106          | I/O                 | I/O                  | I/O                 | 142        | I/O                 | I/O                  | I/O                 |
| 107          | I/O                 | I/O                  | I/O                 | 143        | I/O                 | I/O                  | I/O                 |
| 108          | I/O                 | I/O                  | I/O                 | 144        | TCK, I/O            | TCK, I/O             | TCK, I/O            |

# 176-Pin TQFP



Figure 2-4 • 176-Pin TQFP (Top View)

## Note

For Package Manufacturing and Environmental information, visit the Package Resource center at http://www.actel.com/products/rescenter/package/index.html.

| 329-Pin PBGA  |                     | 329-Pin PBGA  |                     | 329-Pin PBGA  |                     | 329-Pin PBGA  |                     |
|---------------|---------------------|---------------|---------------------|---------------|---------------------|---------------|---------------------|
| Pin<br>Number | A54SX32<br>Function | Pin<br>Number | A54SX32<br>Function | Pin<br>Number | A54SX32<br>Function | Pin<br>Number | A54SX32<br>Function |
| A1            | GND                 | AA13          | I/O                 | AC2           | V <sub>CCI</sub>    | B14           | I/O                 |
| A2            | GND                 | AA14          | I/O                 | AC3           | NC                  | B15           | I/O                 |
| A3            | V <sub>CCI</sub>    | AA15          | I/O                 | AC4           | I/O                 | B16           | I/O                 |
| A4            | NC                  | AA16          | I/O                 | AC5           | I/O                 | B17           | I/O                 |
| A5            | I/O                 | AA17          | I/O                 | AC6           | I/O                 | B18           | I/O                 |
| A6            | I/O                 | AA18          | I/O                 | AC7           | I/O                 | B19           | I/O                 |
| A7            | V <sub>CCI</sub>    | AA19          | I/O                 | AC8           | I/O                 | B20           | I/O                 |
| A8            | NC                  | AA20          | TDO, I/O            | AC9           | V <sub>CCI</sub>    | B21           | I/O                 |
| A9            | I/O                 | AA21          | V <sub>CCI</sub>    | AC10          | I/O                 | B22           | GND                 |
| A10           | I/O                 | AA22          | I/O                 | AC11          | I/O                 | B23           | V <sub>CCI</sub>    |
| A11           | I/O                 | AA23          | V <sub>CCI</sub>    | AC12          | I/O                 | C1            | NC                  |
| A12           | I/O                 | AB1           | I/O                 | AC13          | I/O                 | C2            | TDI, I/O            |
| A13           | CLKB                | AB2           | GND                 | AC14          | I/O                 | C3            | GND                 |
| A14           | I/O                 | AB3           | I/O                 | AC15          | NC                  | C4            | I/O                 |
| A15           | I/O                 | AB4           | I/O                 | AC16          | I/O                 | C5            | I/O                 |
| A16           | I/O                 | AB5           | I/O                 | AC17          | I/O                 | C6            | I/O                 |
| A17           | I/O                 | AB6           | I/O                 | AC18          | I/O                 | С7            | I/O                 |
| A18           | I/O                 | AB7           | I/O                 | AC19          | I/O                 | C8            | I/O                 |
| A19           | I/O                 | AB8           | I/O                 | AC20          | I/O                 | С9            | I/O                 |
| A20           | I/O                 | AB9           | I/O                 | AC21          | NC                  | C10           | I/O                 |
| A21           | NC                  | AB10          | I/O                 | AC22          | V <sub>CCI</sub>    | C11           | I/O                 |
| A22           | V <sub>CCI</sub>    | AB11          | PRB, I/O            | AC23          | GND                 | C12           | I/O                 |
| A23           | GND                 | AB12          | I/O                 | B1            | V <sub>CCI</sub>    | C13           | I/O                 |
| AA1           | V <sub>CCI</sub>    | AB13          | HCLK                | B2            | GND                 | C14           | I/O                 |
| AA2           | I/O                 | AB14          | I/O                 | В3            | I/O                 | C15           | I/O                 |
| AA3           | GND                 | AB15          | I/O                 | В4            | I/O                 | C16           | I/O                 |
| AA4           | I/O                 | AB16          | I/O                 | B5            | I/O                 | C17           | I/O                 |
| AA5           | I/O                 | AB17          | I/O                 | B6            | I/O                 | C18           | I/O                 |
| AA6           | I/O                 | AB18          | I/O                 | В7            | I/O                 | C19           | I/O                 |
| AA7           | I/O                 | AB19          | I/O                 | B8            | I/O                 | C20           | I/O                 |
| AA8           | I/O                 | AB20          | I/O                 | В9            | I/O                 | C21           | V <sub>CCI</sub>    |
| AA9           | I/O                 | AB21          | I/O                 | B10           | I/O                 | C22           | GND                 |
| AA10          | I/O                 | AB22          | GND                 | B11           | I/O                 | C23           | NC                  |
| AA11          | I/O                 | AB23          | I/O                 | B12           | PRA, I/O            | D1            | I/O                 |
| AA12          | I/O                 | AC1           | GND                 | B13           | CLKA                | D2            | I/O                 |

| 329-Pin PBGA  |                     |  |  |  |
|---------------|---------------------|--|--|--|
| Pin<br>Number | A54SX32<br>Function |  |  |  |
| T22           | I/O                 |  |  |  |
| T23           | I/O                 |  |  |  |
| U1            | I/O                 |  |  |  |
| U2            | I/O                 |  |  |  |
| U3            | V <sub>CCA</sub>    |  |  |  |
| U4            | I/O                 |  |  |  |
| U20           | I/O                 |  |  |  |
| U21           | V <sub>CCA</sub>    |  |  |  |
| U22           | I/O                 |  |  |  |
| U23           | I/O                 |  |  |  |
| V1            | V <sub>CCI</sub>    |  |  |  |
| V2            | I/O                 |  |  |  |
| V3            | I/O                 |  |  |  |

| 329-Pin PBGA  |                     |  |  |  |
|---------------|---------------------|--|--|--|
| Pin<br>Number | A54SX32<br>Function |  |  |  |
| V4            | I/O                 |  |  |  |
| V20           | I/O                 |  |  |  |
| V21           | I/O                 |  |  |  |
| V22           | I/O                 |  |  |  |
| V23           | I/O                 |  |  |  |
| W1            | I/O                 |  |  |  |
| W2            | I/O                 |  |  |  |
| W3            | I/O                 |  |  |  |
| W4            | I/O                 |  |  |  |
| W20           | I/O                 |  |  |  |
| W21           | I/O                 |  |  |  |
| W22           | I/O                 |  |  |  |

| 329-Pin PBGA  |                     |  |  |  |
|---------------|---------------------|--|--|--|
| Pin<br>Number | A54SX32<br>Function |  |  |  |
| W23           | NC                  |  |  |  |
| Y1            | NC                  |  |  |  |
| Y2            | I/O                 |  |  |  |
| Y3            | I/O                 |  |  |  |
| Y4            | GND                 |  |  |  |
| Y5            | I/O                 |  |  |  |
| Y6            | I/O                 |  |  |  |
| Y7            | I/O                 |  |  |  |
| Y8            | I/O                 |  |  |  |
| Y9            | I/O                 |  |  |  |
| Y10           | I/O                 |  |  |  |
| Y11           | I/O                 |  |  |  |

| 329-Pin PBGA  |                     |  |  |  |
|---------------|---------------------|--|--|--|
| Pin<br>Number | A54SX32<br>Function |  |  |  |
| Y12           | V <sub>CCA</sub>    |  |  |  |
| Y13           | V <sub>CCR</sub>    |  |  |  |
| Y14           | I/O                 |  |  |  |
| Y15           | I/O                 |  |  |  |
| Y16           | I/O                 |  |  |  |
| Y17           | I/O                 |  |  |  |
| Y18           | I/O                 |  |  |  |
| Y19           | I/O                 |  |  |  |
| Y20           | GND                 |  |  |  |
| Y21           | I/O                 |  |  |  |
| Y22           | I/O                 |  |  |  |
| Y23           | I/O                 |  |  |  |



# 144-Pin FBGA



Figure 2-8 • 144-Pin FBGA (Top View)

### Note

For Package Manufacturing and Environmental information, visit the Package Resource center at http://www.actel.com/products/rescenter/package/index.html.